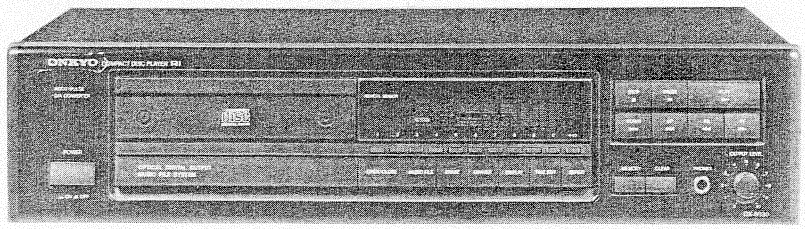
Ref. No. 3395

ONKYO® SERVICE MANUAL

COMPACT DISC PLAYER
MODEL DX-6830



Black and Silver models

SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK ⚠ ON THE SCHEMATIC DIAGRAM AND IN THE PARTS LIST ARE CRITICAL FOR RISK OF FIRE AND ELECTRIC SHOCK. REPLACE THESE COMPONENTS WITH ONKYO PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL.

MAKE LEAKAGE-CURRENT OR RESISTANCE MEASUREMENTS TO DETERMINE THAT EXPOSED PARTS ARE ACCEPTABLY INSULATED FROM THE SUPPLY CIRCUIT BEFORE RETURNING THE APPLIANCE TO THE CUSTOMER.

SPECIFICATIONS

Signal readout system:	Optical non-contact
Reading rotation:	About 500~200 r.p.m. (constant linear velocity)
Linear velocity:	1.2~1.4m/s
Error correction system:	Cross interleave readsolomon code
Decoded bits:	1 BIT PWM Accu Pulse Quartz System
Sampling frequency:	352.8kHz (8 times oversampling)
Number of channels:	2 (Stereo)
Frequency response:	5Hz~20kHz
Total harmonic distortion:	0.004% (at 1kHz)
Dynamic range:	96dB
Signal to noise ratio:	100dB
Channel separation:	90dB (at 1kHz)
Wow and Flutter:	Below threshold of measurability
Power consumption:	12 watts
Output level:	2 volts r.m.s.
Dimensions (W×H×D):	455×110×305mm 18″×4-3/8″×12″
Weight:	4.9kg. 10.8lbs.

Specifications are subject to change without notice.

ONKYO
AUDIO COMPONENTS

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SERVICE PROCEDURES

1. Safety-check out

After correcting the original service problem,perform the following safety check before releasing the set to the customer:

Connect the insulating-resistance tester between the plug of power supply cord and chassis.

Specifications:More than 10Mohm at 500V.

NOTE ON COMPACT DISC

- **Holding Compact Discs**

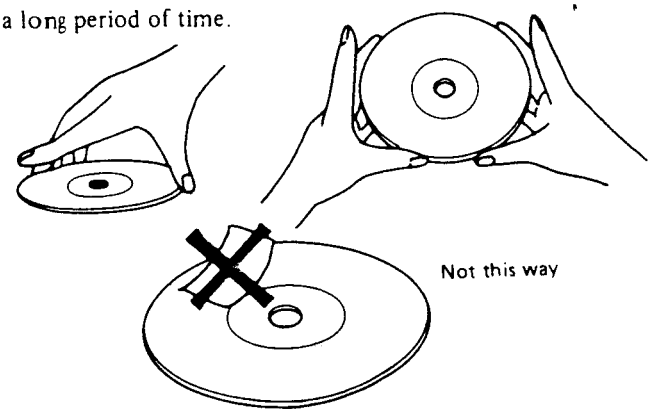
Hold Compact Discs by the edges so that you do not touch the surface of disc. Remember that the side of the disc with the "rainbow" reflection is the side containing the audio information.

Do not attach tape or paper to the label side of the disc and always be careful not to leave fingerprints on the side that is played.

- **Storing Compact Discs**

Store Compact Discs in a location protected from direct sunlight, high heat and humidity and extremely high and low temperatures. Discs should never be left in the trunk or interior of an automobile in the sun since the temperature can become very high in such a closed environment.

Always store Compact Discs in the holders in which they were sold. Never leave a disc in the player's disc holder for a long period of time.



- **Cleaning Compact Discs**

Before playing a disc wipe off the playing surface with a soft cloth to remove dust and other soil. Wipe the surface in straight lines from the center of the disc outward, not in a circular motion as you would with a phonograph record.

Do not use benzene, chemical cleansers or phonograph record cleaning solutions to clean Compact Discs. Also avoid static electricity prevention solutions since they can damage the surface of Compact Discs.

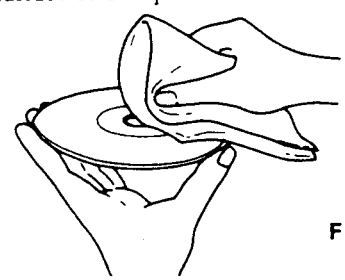


Fig. 9

Problems Caused by Dew

Dew can form inside a Compact player when it is brought from a cold environment into a warm room, when a room is rapidly heated and if a player is left in a humid environment.

This dew can prevent the laser pickup from reading the data contained in the pits in the disc surface. If the player does not operate properly because of dew, remove the disc and leave the player's power switch on for about one hour to remove all moisture.

CAUTION ON REPLACEMENT OF OPTICAL PICKUP

The laser diode in the optical pickup block is so sensitive to static electricity,surge current and etc, that the components are liable to be broken down or its reliability remarkably deteriorated.

During repair,carefulley take the following precautions. (The following precautions are included in the service parts.)

PRECAUTIONS

1.Ground for the work-desk.
Place a conductive sheet such as a sheet of copper (with inpedance lower than 10MΩ) on the work-desk and place the set on the conductive sheet so that the chassis.

2.Grounding for the test equipment and tools.
Test equipments and toolings should be grounded in order that their ground level is the same the ground of the power source.

3.Grounding for the human body.
Be sure to put on a wrist-strap for grounding whose other end is grounded.
Be particularly careful when the workers wear synthetic fiber clothes, or air is dry.

4.Select a soldering iron that permits no leakage and have the tip of the iron well-grounded.

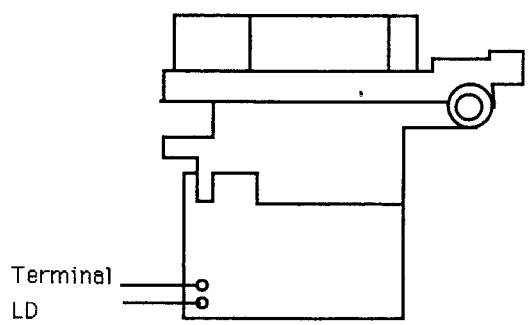
5.Do not check the laser diode terminals with the probe of a circuit tester or oscilloscope.

Care Should be taken with the optical pickup.

The optical pickup is sensitive to static electricity,surge currents,and other high electrical noise, and because there is the possibility of damage to performance, in the handling of the pickup, the utmost care must be taken, particularly with regard to static electricity.

1. When checking the laser terminal, avoid making connections using the probes of a tester or oscilloscope, or an ordinary power supply.

2. When replacing the optical pickup, first short the LD terminals and remove the connector. Also, when attaching the new optical pickup, after attaching the connector, unsolder the LD terminals.



Optical pickup

PROTECTION OF EYES FROM LASER BEAM DURING SERVICING

This set employs a laser. Therefore, be sure to follow carefully the instructions below when servicing.

WARNING!!

WHEN SERVICING, DO NOT APPROACH THE LASER EXIT WITH THE EYE TOO CLOSELY. IN CASE IT IS NECESSARY TO CONFIRM LASER BEAM EMMISION, BE SURE TO OBSERVE FROM A DISTANCE OF MORE THAN 30cm FROM THE SURFACE OF THE OBJECTIVE LENS ON THE OPTICAL PICK-UP BLOCK.

Laser Diode Properties

- Material: GaAS/GaAlAs
- Wavelength: 780nm
- Emission Duration: continuous
- Laser output: max. 0.5mW*

  *This output is the value measured at a distance about 1.8mm from the objective lens surface on the Optical Pick-up Block.

LASER WARNING LABEL

The label shown below are affixed.

1. **Warning lable**
   This label is located on the arm of mechanism.

Ⓐ

DANGER —INVISIBLE LASER RADIATION WHEN OPEN AND INTERLOCK FAILED OR DEFEATED. AVOID DIRECT EXPOSURE TO BEAM

CAUTION —HAZARDOUS LASER AND ELECTROMAGNETIC RADIATION WHEN OPEN AND INTERLOCK DEFEATED.

ATTENTION —RAYONNEMENT LASER ET ELECTROMAGNETIQUE DANGEREUX SI OUVERT AVEC L'ECLENCHEMENT DE SECURITE ANNULE.

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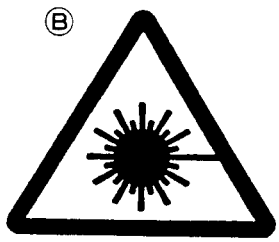

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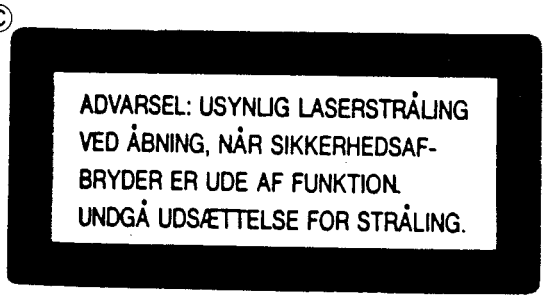
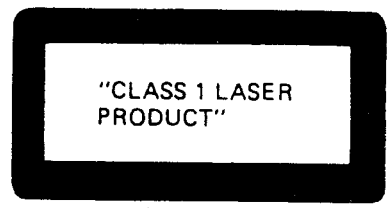


2. **Class 1 label**
   This label is located on the back panel.



ADVARSEL

Denne mærkning er anbragt på apparatets højre side og indikerer, at apparatet arbejder med laserstråler af klasse 1, hvilket betyder, at der anvendes laserstråler af svageste klasse, og at man ikke på apparatets yderside kan blive udsat for utilladelig kraftig stråling.

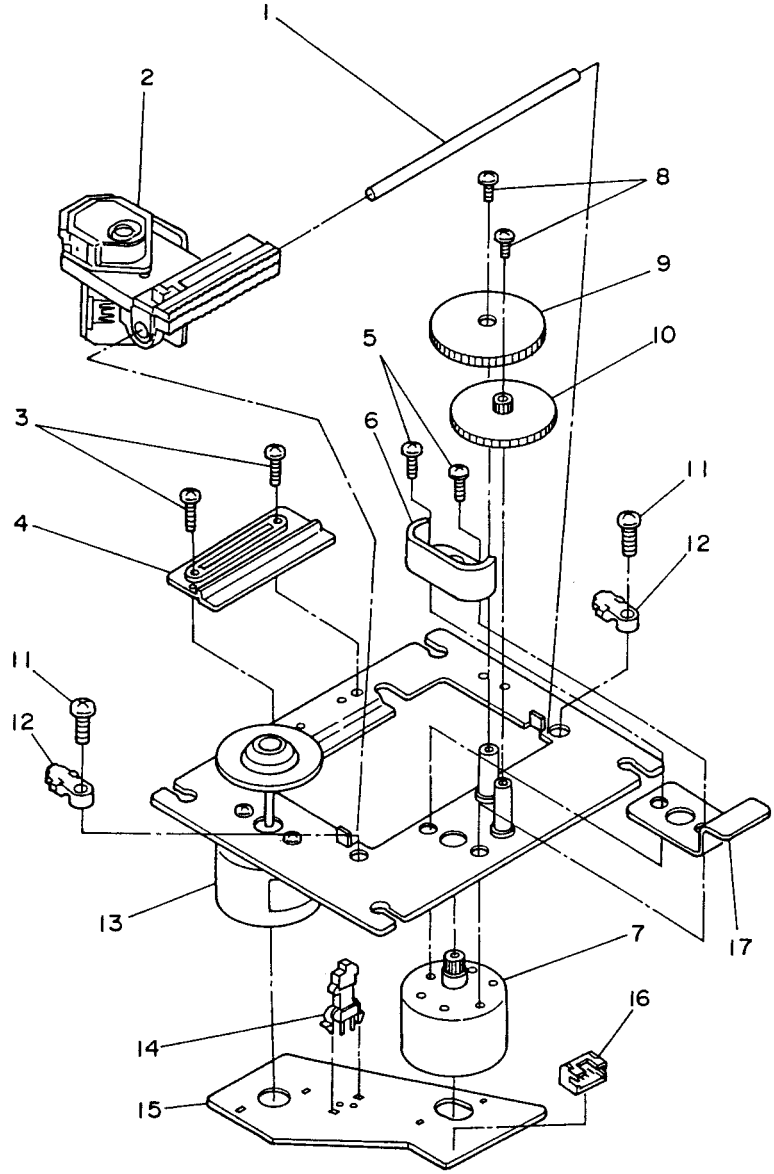
APPARATET BØR KUN ÅBNES AF FAGFOLK MED SÆRLIGT KENDSKAB TIL APPARATER MED LASERSTRÅLER!

Indvendigt i apparatet er anbragt den her gengivne advarselsmærkning, som advarer imod at foretage sådanne indgreb i apparatet, at man kan komme til at udsætte sig for laserstråling.

VAROITUS! Laite sisältää laserdiodin, joka lähettää (näkymätöntä) silmille vaarallista lasersäteilyä.

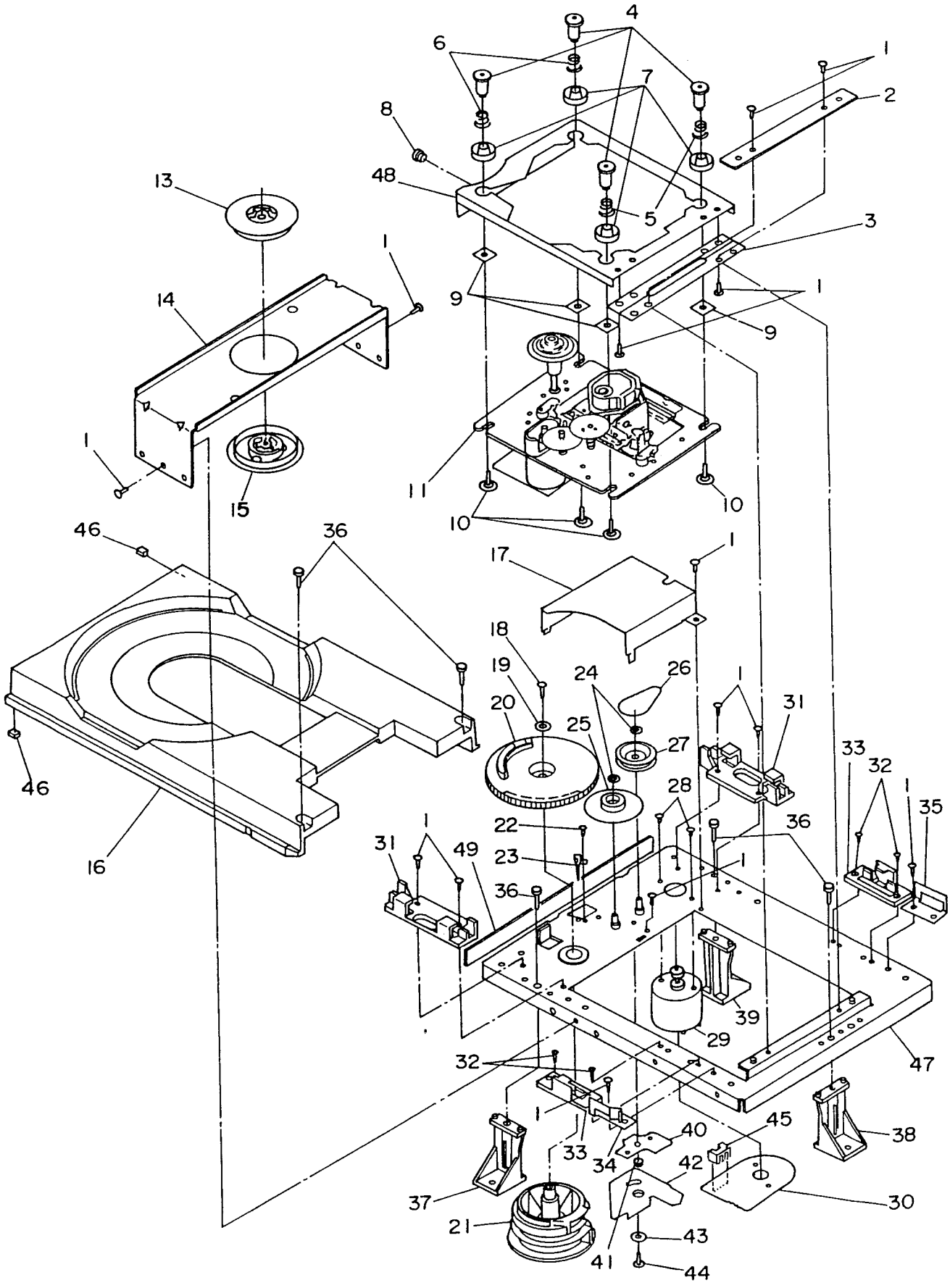
MECHANISM-EXPLODED VIEW

PICKUP DRIVE UNIT-EXPLOVED VIEW



PARTS LIST

REF.NO.	PART NO.	DESCRIPTION	REF.NO.	PART NO.	DESCRIPTION
1	24506900	Slide shaft	10	24506904	Wheel B
2	24110008	KSS-210A,Optical pickup	11	801427	STP2.6×8,Special screw
3	801425	S2×5,Special screw	12	24506905	Shaft clamp
4	24506901	Slide holder	13	24502263	Spindle motor ass'y
5	82112005	P2×5,Pan head screw	14	25065403	NLF-1220,Leafswitch
6	24506902	Gear cover	15	24505271	Motor pc board
7	24502262	Sled motor ass'y	16	25050396	NSCT-4P223,Socket
8	801426	M1.7×3,Special screw	17	24506906	Stopper
9	24506903	Wheel A			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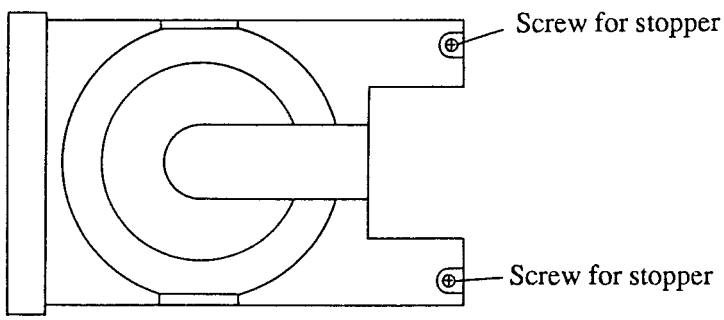
PARTS LIST

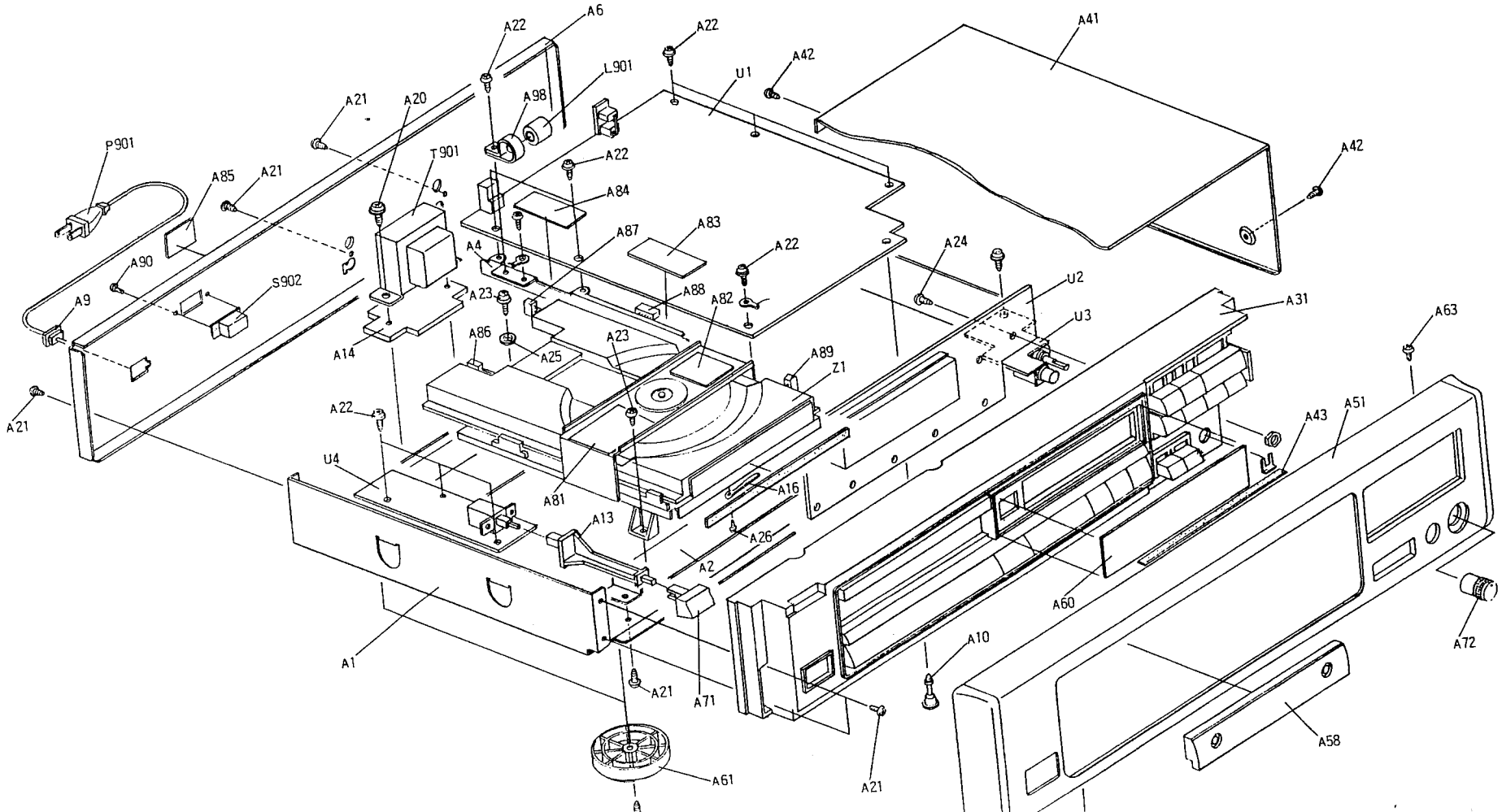
REF.NO.	PART NO.	DESCRIPTION	REF.NO.	PART NO.	DESCRIPTION
1	834126069	2.6TTS+6C,Self-tapping screw	26	24602507	Belt
2	24506864	Holder,hinge	27	24506884	Pulley,loading
3	24506865	Hinge	28	838426038	2.6TTB+3C(BC),Self-tapping screw
4	24506866	Shaft	29	24506886	Motor ass'y
5	27180441	Spring	30	24505269	Motor pc board
6	27180442	Spring	31	27301228	Holder,tray
7	24509401	Insulator	32	833120047	2TTP+4S,Self-tapping screw
8	24506870	Roller	33	27301230	Tray holder
9	24506871	Plate	34	24506887	Tray guide R
10	801424	Screw with washer	35	24506888	Tray guide L
11	24506971	KSM-210AFM,Pickup drive unit	36	838430108	3TTB+10B(BC),Self-tapping screw
13	24506875	Magnet	37	24506889	Boss R
14	24506876	Chassis,chucking	38	24506890	Boss B
15	24506959	Pulley,chucking	39	24506891	Boss L
16	24506878	Tray	40	24506892	Link plate
17	24506879	Cover	41	24506893	Boss
18	838426108	2.6TTB+10B(BC),Self-tapping screw	42	24506894	Stopper link
19	8761301008	W3×10F,Washer	43	24506895	Spacer
20	24506882	Drive gear	44	83112608	2.6TTW+8S,Self-tapping screw
21	24506883	Control cam	45	25050393	NCNT-5220,Connector
22	834120049	2TTS+4C,Self-tapping screw	46	24506897	Damper
23	25065402	NLF-1219,Leafswitch	47	27301224	Main chassis
24	870114	Washer	48	24506898	Sub chassis
25	27301227	Middle gear	49	28140980	Adhesive tape,front

REMOVEMENT OF DISC TRAY



1.Loosen the screw for stopper until the head of screw and the tray are the same height.
2.Turn POWER switch to on.
3.Prees OPEN/CLOSE button to open the tray.
4.Turn POWER switch to off.
5.Remove the tray.

CHASSIS-EXPLODED VIEW



PARTS LIST

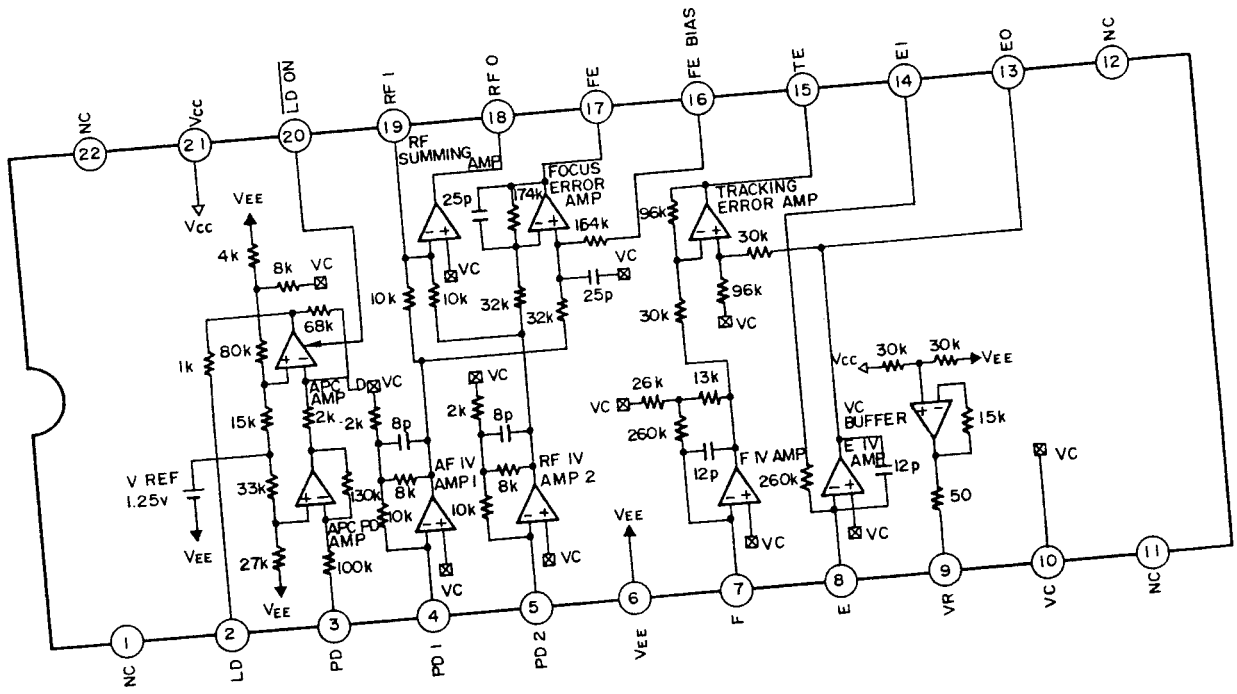
REF. NO.	PART NO.	DESCRIPTON
A1	27100227AY	Chassis
A2	27141436AY	Bracket F
A3	27141437Y	Bracket R
A4	27130642Y	Bracket C
A6	27121405Y	Back panel
A9	27300750	⚠ Bushing
A10	27190524	KGLS-14R,Holder
A13	27273134Y	Joint,power
A14	27270214B	Spacer
A16	27255004	CS-1U,Clip
A20	830440109	4TTC+10C(BC),Self-tapping screw
A21	834430088	3TTS+8B(BC),Self-tapping screw
A22	831130088	3TTW+8B,Self-tapping screw
A23	834430108	3TTS+10B(BC),Self-tapping screw
A24	833430080	3TTP+8P(BC),Self-tapping screw
A25	87643010	W3×10F(BC),Washer
A26	834426068	2.6TTS+6B(BC),Self-tapping screw
A31	27110602AY	Front bracket ass'y <B>
	27110603AY	Front bracket ass'y <S>
A41	28184469Y	Top cover
A42	834430088	3TTS+8B(BC),Self-tapping screw
A43	28140680	0.5×8×180,Cushion
A51	1H158121	Front panel ass'y <B>
	1H159121	Front panel ass'y <S>
	28125222Y	End cap L
	28125223Y	End cap R
A58	27211246Y	Tray panel <B>
	27211258	Tray panel <S>
A60	28191574Y	Clear plate
A61	27175254Y	Leg
A62	834430088	3TTS+8B(BC),Self-tapping screw
A63	833430080	3TTP+8P(BC),Self-tapping screw
A71	28324140Y	Knob,power <B>
	28324184	Knob,power <S>
A72	28324150Y	Knob,level <B>
	28324151Y	Knob,level <S>
A81	29360807	Label DANGER
A82	29361218Y	Label LASER
A85	29360687	Label CLASS1
A86	2000951	NSAS-8P903,Socket
A87	2000952	NSAS-8P904,Socket
A88	2002390810	NSAS-8P0120,Socket
A89	2002391020	NSAS-10P0119,Socket
A97	2061112100Y	Cord ass'y
A98	260221	NK-10N,Clamp
A99	260208	Binder
L901	230907	⚠ TR-16-8-16,Core
P901	253164Y	⚠ AS-CEE250V2.5A,Power supply cord
T901	2300620Y	⚠ NPT-1094P,Power transformer
U1	1H156578-3A	NAAR-4078-3a,Main circuit pc board ass'y
U2	1H156579-3	NADIS-4079-3,Display circuit pc board ass'y
U3	1H156580-3	NAAF-4080-3,Headphone amplifier pc board ass'y
U4	1H156581-3	NAPS-4081-3,Power supply pc board ass'y
Z1	24506957Y	NCD-112S,CD mechanism ass'y

NOTE:<B>:Only Black Model
<S>:Only Silver Model

NOTE: THE COMPONENTS IDENTIFIED BY MARK ⚠ ARE CRITICAL FOR RISK OF FIRE AND ELECTRIC SHOCK. REPLACE ONLY WITH PART NUMBER SPECIFIED.

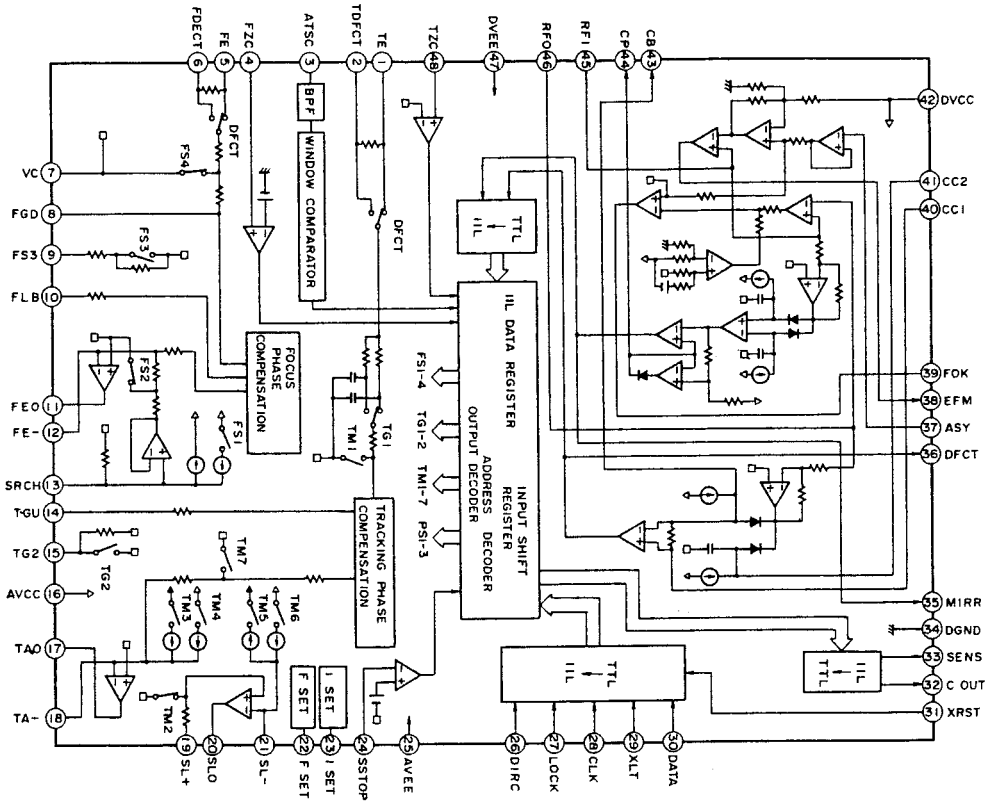
IC BLOCK DIAGRAM AND DESCRIPTIONS

CXA1571S (RF Amp)



Pin No.	Symbol	I/O	Description
2	LD	O	Output terminal of APC amplifier.
3	PD	I	Input terminal of APC amplifier.
4	PD1	I	Inversion input terminal for RF I-V amplifier. Connect to photo diode A+C.
5	PD2	I	Inversion input terminal for RF I-V amplifier. Connect to photo diode B+D.
7	F-IN	I	Inversion input terminal for F I-V amplifier. Connect to photo diode F.
8	E-IN	I	Inversion input terminal for E I-V amplifier. Connect to photo diode E.
9	VR	O	DC voltage output of (Vcc+V_{EE})/2.
10	VC	I	Middle point voltage input terminal.
13	EO	O	Monitor output terminal for I-V amplifier E.
14	EI	-	Gain adjustment terminal for I-V amplifier E.
15	TE	O	Tracking error amplifier output terminal. The signal E-F is output from this terminal.
16	FE-BIAS	I	Bias adjustment terminal for non-inversion side of focus error amplifier.
17	FE	O	Focus error amplifier output terminal.
18	RFO	O	RF amplifier output terminal.
19	RFI	I	Inversion input terminal of RF amplifier.
20	LD-ON	I	Change-over terminal for APC amplifier.

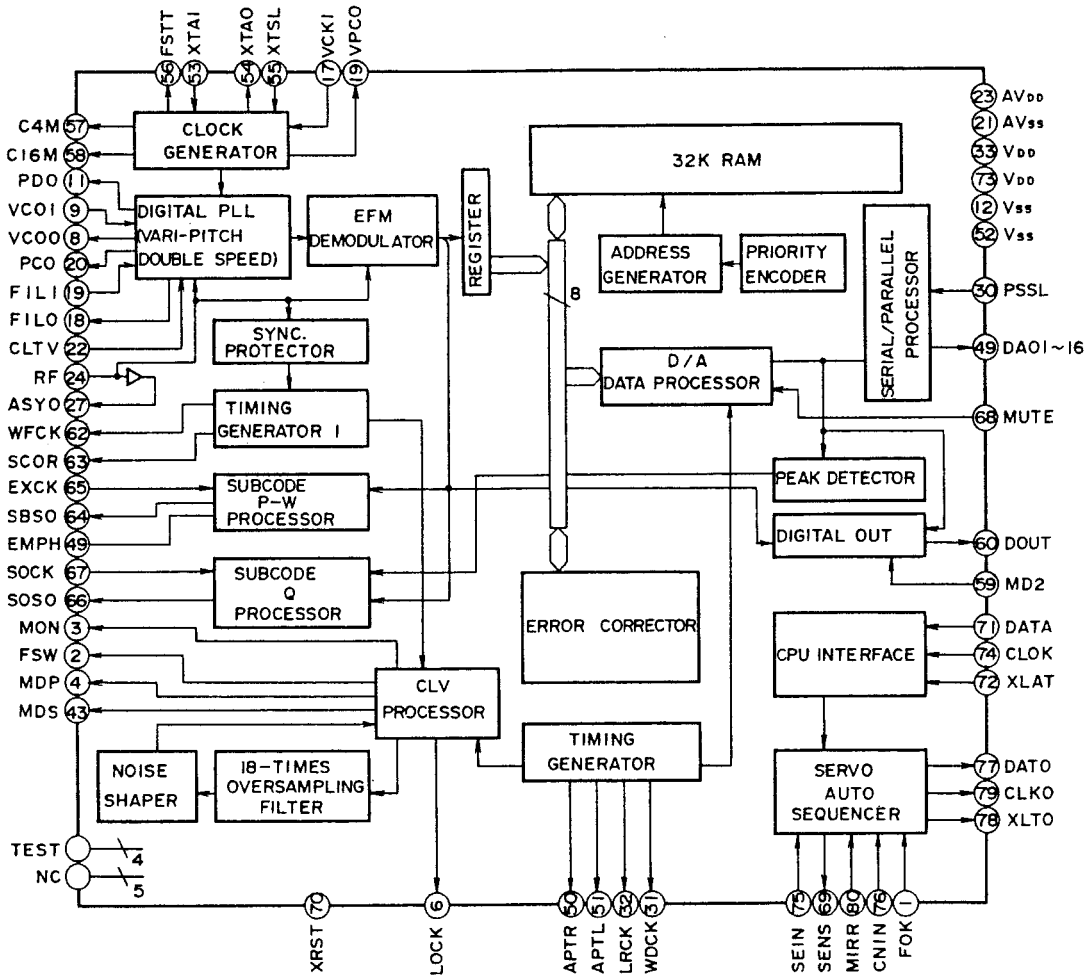
CXA1372S (Servo Signal Processor)



PIN. NO.	SYMBOL	I/O	DESCRIPTION
1	TE	I	Tracking error input terminal.
2	TDFCT	I	Capacitor connection terminal for time constant when defect.
3	ATSC	I	Window comparator input terminal for ATSC detection.
4	FZC	I	Focus zero-cross comparator input terminal.
5	FE	I	Focus error input terminal.
6	FDFCT	I	Capacitor connection terminal for time constant when detect.
7	VC	I	Mid-point voltage input terminal.
8	FGD	I	Connect the capacitor between pin 9 and this pin when the high frequency gain of focus servo is dropped.
9	FS3	I	Focus servo high frequency gain changeover input terminal.
10	FLB	I	Input terminal for the low frequency boost of focus servo.
11	FEO	O	Focus drive output terminal.
12	FE-	I	Inversion input terminal of focus amplifier.
13	SRCH	I	Time constant terminal to make the focus search waveform.
14	TGU	I	Tracking high frequency gain changeover input terminal.
15	TG2	I	Tracking high frequency changeover input terminal.
17	TAO	O	Tracking drive output terminal.
18	TA-	I	Inversion input terminal of tracking amplifier.
19	SL+	I	No-inversion input terminal of sled amplifier.
20	SLO	O	Sled(slide) drive output terminal.
21	SL-	I	Inversion input terminal of sled amplifier.

PIN. NO.	SYMBOL	I/O	DESCRIPTION
22	FSET	I	Peak setting input of phase correction of focus tracking.
23	ISET	I	This terminal is flowed the current so that the focus search, tracking jump, and sled kick height is decided.
24	SSTOP	I	Inner switch selection input terminal.
26	DIRC	I	This terminal is used when a track jump.
27	LOCK	I	The sled runaway prevention circuit operates at the low level.
28	CLK	I	Serial data transfer clock input from microprocessor.
29	XLT	I	Latch input from microprocessor.
30	DATA	I	Serial data input from microprocessor.
31	XRST	I	Reset input terminal. Active low.
32	C. OUT	O	Signal output to count the track numbers.
33	SENS	O	This terminal outputs FZC, and SSTOP to according command from microprocessor.
35	MIRR	O	Mirror comparator output terminal.
36	DFCT	O	Defect comparator output terminal.
37	ASY	I	Auto asymmetry control input terminal.
38	EFM	O	EFM comparator output terminal.
39	FOK	O	Focus OK comparator output terminal.
40	CCI	O	Defect bottom hold output terminal.
41	CC2	I	Defect bottom hold input terminal from CCI.
43	CB	I	Defect bottom hold capacitor connection terminal.
44	CP	I	Mirror hold capacitor connection terminal.
45	RFI	I	RF summing amplifier input terminal.
46	RFO	O	RF summing amplifier output terminal.
48	TZC	I	Tracking zero-cross comparator input terminal.

CXD2500Q (Digital Signal Processor)



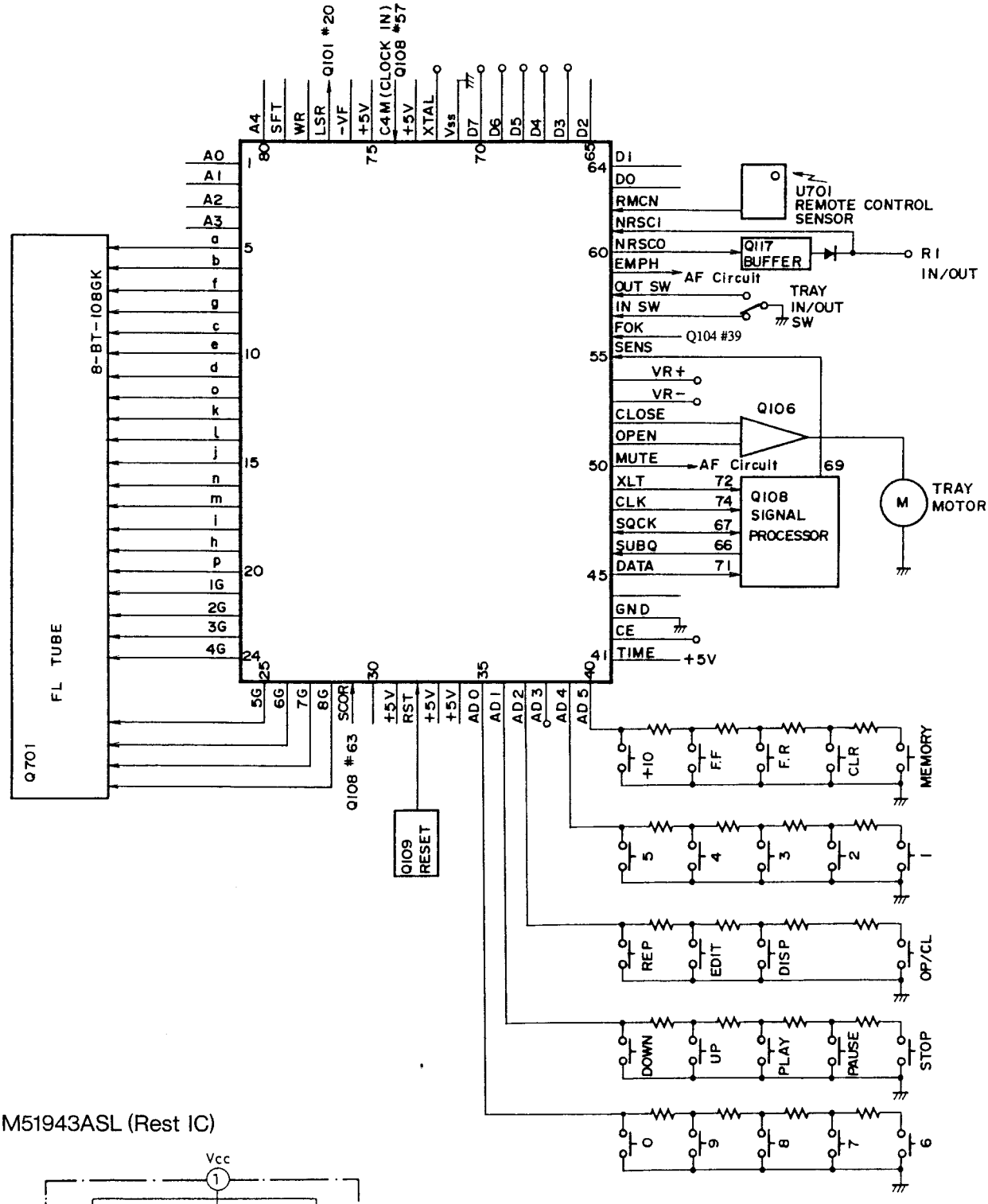
NO.	SYMBOL	I/O	DESCRIPTION
1	FOK	I	Focus OK input
2	FSW	O	Output filter changeover output of spindle motor
3	MON	O	Spindle motor control output
4	MDP	O	Spindle motor servo control
5	MDS	O	Spindle motor servo control
6	LOCK	O	H when GFS is high
7	NC		
8	VCOO	O	Oscillation circuit output for analog FEM PLL
9	VCOI	I	Oscillation circuit input for analog EFM PLL (8.6436MHz)
10	TEST	I	Test terminal
11	PDO	O	Charge pump output for analog EFM PLL
12	Vss		Ground terminal
13-15	NC		
16	VPCO	O	PLL charge pump output for variable pitch
17	VCKI	I	Clock input for variable pitch from VCO (16.934MHz)
18	FILO	O	Filter output for master PLL
19	FILI	I	Filter input for master PLL
20	PCO	O	Charge pump output for master PLL
21	AVss		Analog ground
22	CLTV	I	VCO control voltage input for master
23	AVDD		Analog section power supply (+5V)
24	RF	I	EFM signal input
25	TEST2	I	Connect to the ground.
26	TEST3	I	Connect to the ground.
27	ASYO	O	EFM full swing output
28	TEST4	I	Connect to the ground.
29	NC		
30	PSSL	I	Audio data output mode changeover input. Serial data at L and paraller data at H.
31	WDCK	O	D/A interface for 48 bits slot. Word clock f=2Fs.
32	LRCK	O	D/A interface for 48 bits slot. LR clock f=Fs.
33	VDD		Power supply terminal (+5V)
34-49			Data output terminals

			PSSL=1	PSSL=0
34	DA16	O	DA16	Serial data of 48 bits slot
35	DA15	O	DA15	Bit clock of 48 bits slot
36	DA14	O	DA14	Serial data of 64 bits slot
37	DA13	O	DA13	Bit clock of 68 bits slot
38	DA12	O	DA12	LR clock of 68 bits slot
39	DA11	O	DA11	GTOP output
40	DA10	O	DA10	XUGF output
41	DA09	O	DA09	XPLCK output
42	DA08	O	DA08	GFS output
43	DA07	O	DA07	RFCK output
44	DA06	O	DA06	C2PO output
45	DA05	O	DA05	XRAOF output
46	DA04	O	DA04	MNT3 output
47	DA03	O	DA03	MNT2 output
48	DA02	O	DA02	MNT1 output
49	DA01	O	DA01	MNT0 output

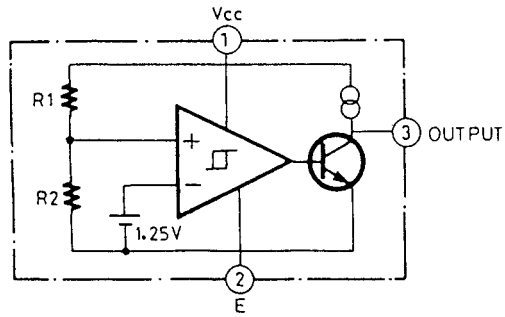
NO.	SYMBOL	I/O	DESCRIPTION
50	APTR	O	Control output for aperture correction. H when Rch.
51	APTI	O	Control output for aperture correction. H when Lch.
52	Vss		Ground
53	XTAI	I	Crystal oscillation circuit input of 16.9344MHz or 33.8688MHz input
54	XTAO	O	Crystal oscillation circuit output of 16.9344MHz
55	XTSL	I	Crystal selection input terminal. L when 16.9344MHz. H when 33.8688MHz.
56	FSTT	O	2/3 divided output of pins 53 & 54
57	C4M	O	4.2336MHz output
58	C16M	O	16.9344MHz output
59	MD2	I	Digital output control input. On at H & Off at L.
60	DOUT	O	Digital output
61	EMPH	O	Emphasis control output. Active H.
62	WFCK	O	Write frame clock output
63	SCOR	O	Sub-code detection output. H when is detected S0 or S1.
64	SBSO	O	Serial output of sub code (P~W)
65	EXCK	I	Clock input for read out SBSO
66	SQSO	O	Sub Q 80 bits, PCM peak, and level data 16 bits output
67	SQCK	I	Clock input for read out SQSO
68	MUTE	O	Muting control output. Active H.
69	SENS	-	Sens output. Output to microprocessor
70	XRST	I	System reset. Rest at low level.
70	DATA	I	Serial data input from microprocessor
72	XLTA	I	Latch input from microprocessor. Latch the serial data at trailing.
73	VDD		Power supply
74	CLOK	I	Serial data transfer clock input from microprocessor
75	SEIN	I	Sens input from SSP
76	CNCI	I	Track jump numbers count signal input
77	DATO	O	Serial data output to SSP
78	XLTO	O	Serial data latch output to SSP. Latch at trailing.
79	CLKO	O	Serial data transfer clock output to SSP
80	MIRR	I	Mirror signal input

Note:SSP:Q104 CXA1372S

CXP50112-197Q (Microprocessor)

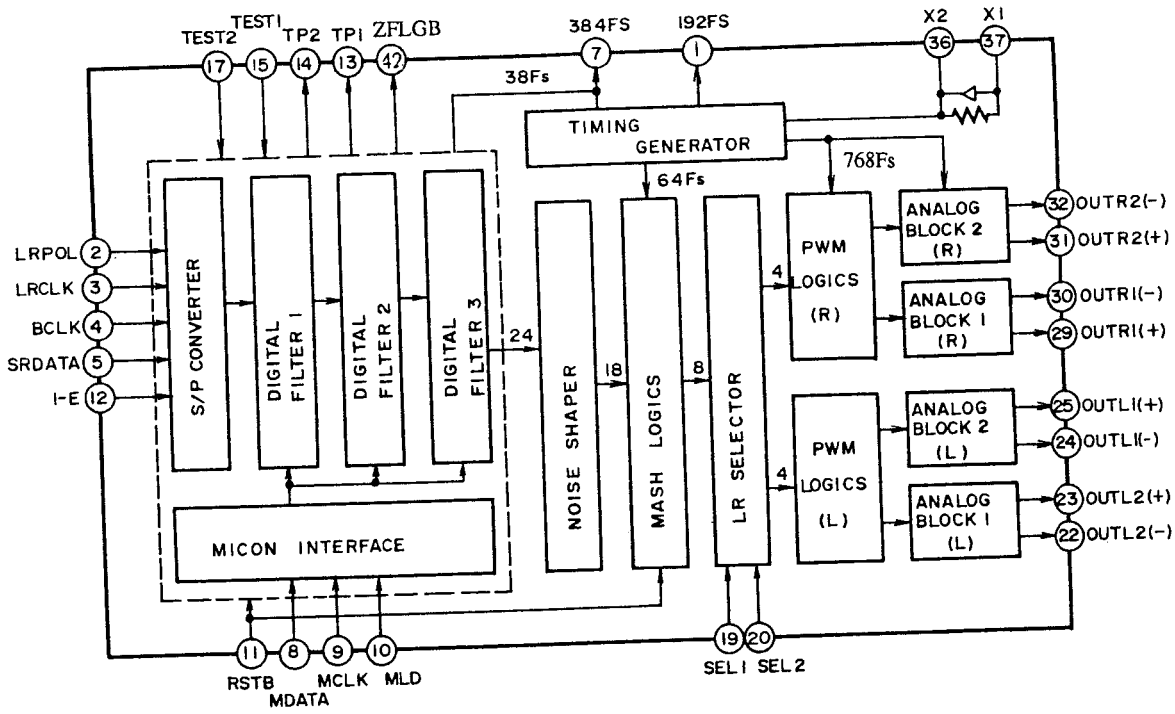


M51943ASL (Rest IC)



Pin No.	Symbol	Description
1～4	A0～A3	Music file address signal.
5～20	a～p	Fluorescent indicator tube segment drive output terminals.
21～28	1G～8G	Fluorescent indicator tube grid drive output terminals.
29	SCOR	Synchronizing signal detection input terminal of sub code frame.
31	5V	
32	RST	Reset input terminal.Reset at the low level.
33,34	5V	
35～40	AD0～AD5	AD input terminal.Connect to the operation key.
41	TIME	Timer switch connection terminal.Not used.
42	CE	Chip enable terminal.
43	GND	
45	DATA	Serial data output terminal.
46	SUBQ	Subcode Q input terminal.
47	SQCK	Subocde Q read clock input/output terminal.
48	CLK	Serial data transmission clock output terminal.
49	XLT	Command execution output terminal.
50	MUTE	Muting ON/OFF control output terminal.ON at the high level.
51	OPEN	Tray open control output terminal.Open at the low level.
52	CLOSE	Tray close control output terminal.Close at the low level.
53	VR-	Volume control output.
54	VR+	Volume control output.
55	SENS	Interface of signal processor and microprocessor ICs.
56	FOK	Focus OK input terminal.Focus OK at the high level.
57	INSW	Tray close detection input terminal.
58	OUTSW	Tray open detection input terminal.
59	EMPH	Emphasis ON/OFF control output terminal.On at the high level.
60	NRSCO	Remote control signal (RI signal) output terminal.
61	NRSCI	Remote control signal (RI signal) input terminal.
62	RMCN	Remote control signal input terminal.
63～70	D0～D7	Music file data signal.
71	Vss	Ground terminal.
72	XTAL	Clock output terminal.
73	5V	
74	C4M	System clock input terminal.
75	5V	
76	VF	Negative power supply terminal for fluorescent indicator tube.
77	LSR	Optical pickup control output terminal.On at the low level.
78	WR	Music file read/write control signal.
79	SFT	Music file shift signal. Control the serial data at the rise pulse.
80	A4	Music file address signal.

MN6472 (D/A Converter)

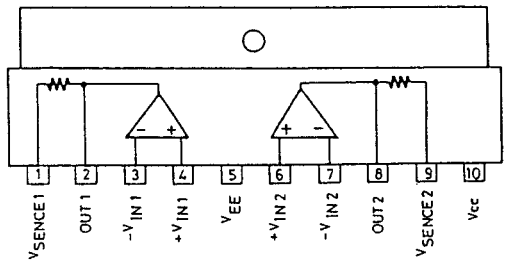


Pin No.	Symbol	Description
1	192FS	192FS(=8.4672MHz) output terminal.
2	LRPOL	Polarity switching terminal for LRCLK.L ch at "H",R ch at "L".
3	LRCLK	Input terminal for LRCLK. At LR-POL"H":Lch data input at "H",Rch data input at "L". At LR-POL"L":Lch data input at "L",Rch data input at "H".
4	BCLK	Serial bit clock input terminal.
5	SRDATA	Input terminal for serial input data.
6	DVSS	Ground terminal for digital system.
7	384FS	384FS=16.9344MHz output terminal.
8	MDATA	Microprocessor command data input terminal.
9	MCLK	Clock input terminal for microprocessor command.
10	MLD	Microprocessor command load input terminal.Load at "L".
11	RSTB	Reset terminal.Reset at "L".
12	I-E	Signal processing LSI format at "L",and I²S format at "H".
13	TP1	Output terminal 1 for digital filter portion test.
14	TP2	Output terminal 2 for digital filter portion test.
15	TEST1	Test signal input terminal 1 for testing digital filter portion. Normally "L".
16	DVDD	Power supply terminal for digital system. (Terminal for COM potential fixing) (+5V)
17	TEST2	Test signal input terminal 2 for testing digital filter portion. Normally "L".
18	NC	
19 20	SEL1 SEL2	

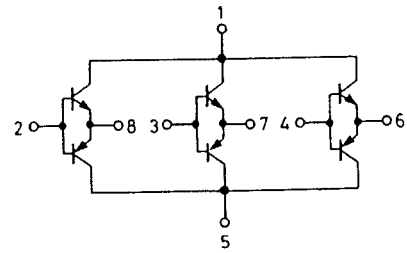
SEL1	SEL2	Output
L	L	Normal stereo output
L	H	Only Lch output
H	L	Only Rch output
H	H	Both Rch and Lch negative output

Pin No.	Symbol	Description
21	AVDD1	Power supply terminal 1 for analog system. (+5V)
22	OUTL2(-)	PWM output terminal for L 2 ch negative phase.
23	OUTL2(+)	PWM output terminal for L 2 ch positive phase.
24	OUTL1(-)	PWM output terminal for L 1 ch negative phase.
25	OUTL1(+)	PWM output terminal for L 1 ch positive phase.
26	AVSS1	Ground terminal 1 for analog system.
27	NC	
28	AVSS2	Ground terminal 2 for analog system.
29	OUTR1(+)	PWM output terminal for R 1 ch positive phase.
30	OUTR1(-)	PWM output terminal for R 1 ch negative phase.
31	OUTR2(+)	PWM output terminal for R 2 ch positive phase.
32	OUTR2(-)	PWM output terminal for R 2 ch negative phase.
33	AVDD2	Power supply terminal 2 for analog system. (+5V)
34	DVDD1	Power supply terminal 1 for digital system. (+5V) (Power supply for oscillation circuit)
35	DVSS1	Ground terminal 1 for digital system. (Ground for oscillation circuit)
36	X2	Crystal oscillation terminal.
37	X1	Crystal oscillation terminal.(External clock input terminal)
38	DVSS2	Ground terminal 2 for digital system.
39	NSUB	Connect to D-VDD.(Potential fixing terminal for Silicon circuit board)
40	DVDD2	Power supply terminal 2 for digital system. (+5V)
41	NC	
42	ZFLGB	Output terminal for zero output detector.

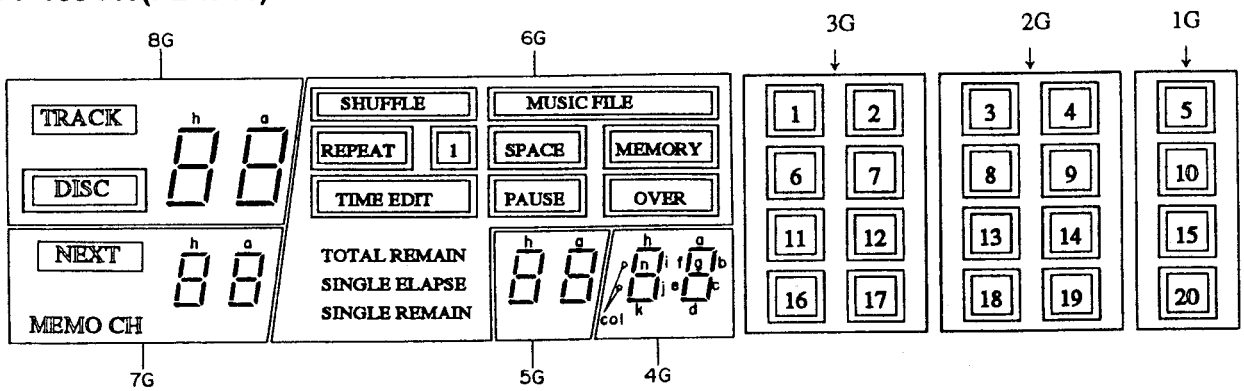
STA341M-L (Transistor Array)



LA6510 (Power OP Amp)



8-BT-108GK (FL tube)



Pin No.	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
Connection	F1	F1	NP	8G	7G	6G	5G	4G	3G	2G	1G	NC	P16	P8	P9	NP	NP	NP	NP	NP
Pin No.	21	22	23	24	25	26	27	28	29	30	31	32	33	34	35	36	37	38	39	
Connection	NP	NP	NP	P13	P14	P10	P12	P11	P15	P4	P5	P3	P7	P6	P2	P1	NP	F2	F2	

NOTE: F1,F2---Filament,NP---No pin,NC---No connection,1G-8G---Grid,P1-P16---Segment

	8G	7G	6G	5G	4G	3G	2G	1G
P1	a	a	REPEAT	a	a	1	3	5
P2	b	b	TIME EDIT	b	b	☐ <1>	☐ <3>	☐ <5>
P3	c	c		c	c	6	8	10
P4	d	d		d	d	7	9	
P5	e	e	1	e	e	☐ <6>	☐ <8>	☐ <10>
P6	f	f	MUSIC FILE	f	f	2	4	
P7	g	g	SPACER	g	g	☐ <2>	☐ <4>	
P8	h	h	PAUSE	h	h	☐ <7>	☐ <9>	
P9	i	i	MEMORY	i	i	11	13	15
P10	j	j	SHUFFLE	j	j	☐ <12>	☐ <14>	
P11	k	k	OVER	k	k	☐ <16>	☐ <18>	☐ <20>
P12	l	l	SINGLE REMAIN	l	l	16	18	20
P13	m	m	SINGLE ELAPSE	m	m	☐ <11>	☐ <13>	☐ <15>
P14	n	n		n	n	12	14	
P15	TRACK	NEXT	TOTAL REMAIN		:	17	19	
P16	DISC	MEMO CH				☐ <17>	☐ <19>	

ADJUSTMENT PROCEDURES

Instruments required

Dual trace oscilloscope, Frequency counter, AF oscillator, Test disc (SONY YEDS-18), AC voltmeter, Jitter meter, and Socket P4(Part no. 25050138)

1. Focus offset adjustment

Load the test disc YEDS-18 on the tray and play the track 2.
Connect the oscilloscope or jitter meter to terminal P106-1.
(Oscilloscope)
Adjust R109 until a clear trace of waveform pattern as shown photo 1 appear on the oscilloscope.
When the amount of jitter is broad, set R110 to mechanical center.
(Jitter meter)
Adjust R109 until the jitter meter reading becomes minimum.(Less than 10ns.)
After adjustment, disconnect the oscilloscope or jittter meter.

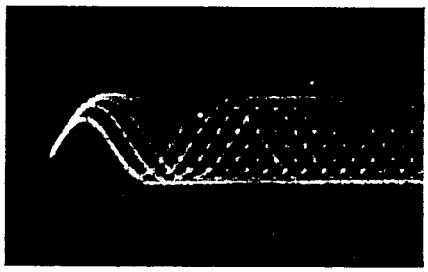
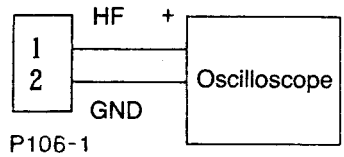
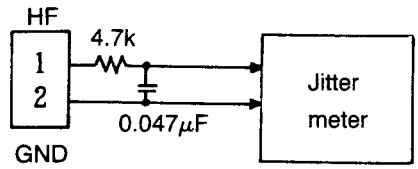


Photo 1



Oscilloscope range
Vertical : 0.5V/div.
Holizontal : 0.2 μs/div.
DC, Ground: Center



2. Tracking offset adjustment

Load the test disc YEDS-18 on the tray and play the track 2.
Turn R116 to minimum position.(Counter clockwise)
Connect the oscilloscope between pin 3 (TR) of P107 and pin 2 (GND) of P106.
Adjust R108 until the center of tracking error signal on the oscilloscope becomes GND level.
Turn R132 to the mechanical center.
After adjustment, disconnect the oscilloscope.

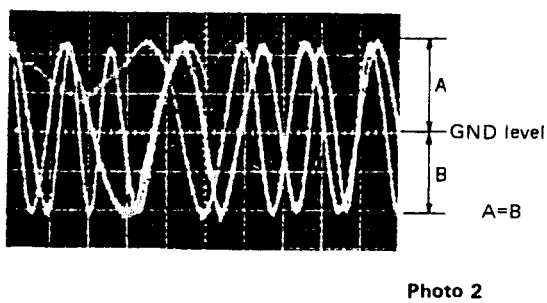
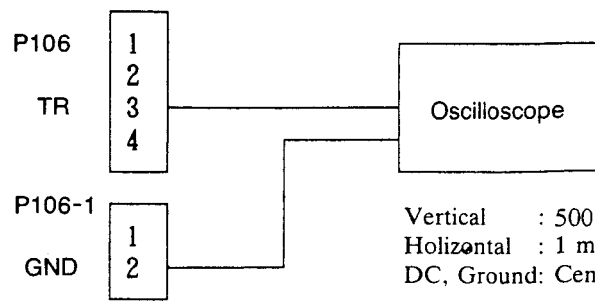


Photo 2



Vertical : 500mV/div.
Holizontal : 1 ms/div.
DC, Ground: Center

3. Focus gain adjustment

Set the output of AF oscillator to 800Hz, 1~1.5Vp-p.
Play the track 2 of test disc.
Connect the oscilloscope and the AF oscillator as shown below.

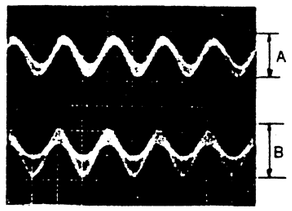
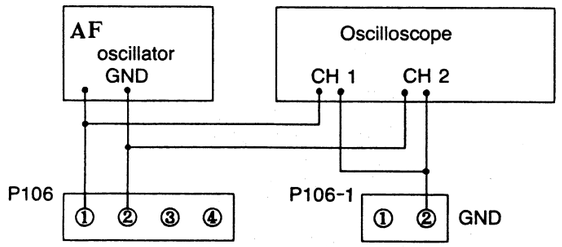


Photo 3



Vertical : 0.2V/div.
Holizontal: 0.5 ms/div.

Adjust R117 until 800Hz components of channels 1 and 2 on oscilloscope become same level.
After adjustment, disconnect the AF oscillator and the oscilloscope.

4. Tracking gain adjustment

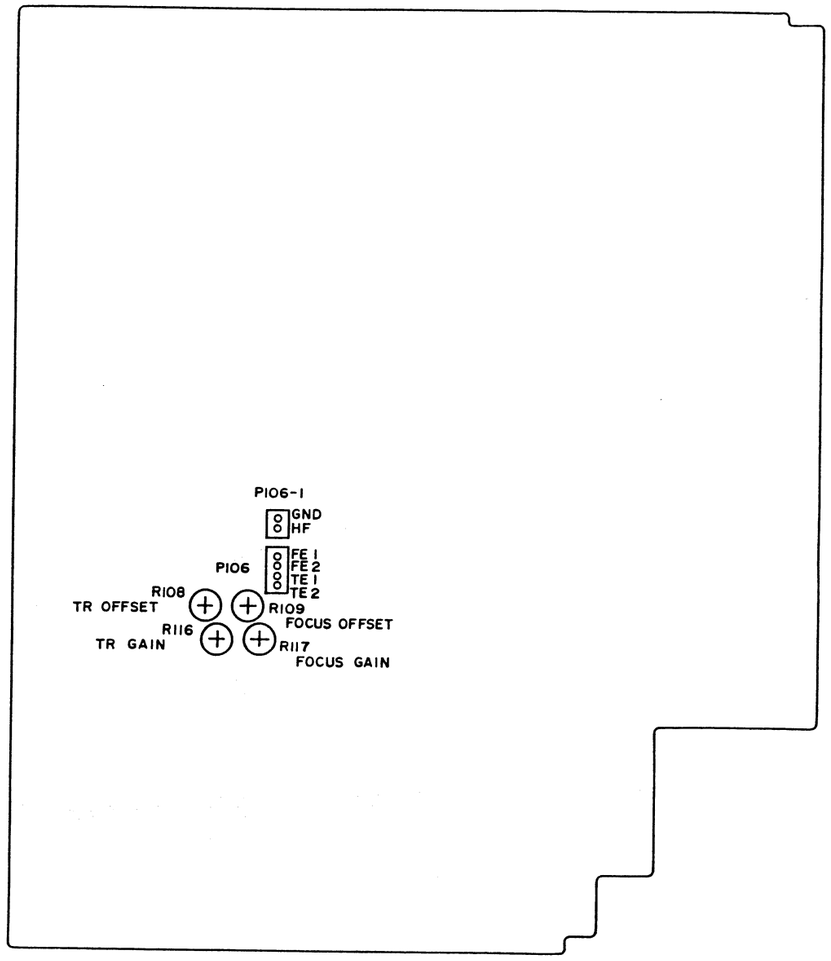
Set the output of AF oscillator to 1.2kHz, 1~1.5Vp-p.
Play the track 2 of test disc.
Connect the oscilloscope and the AF oscillator as shown below.

Photo 4

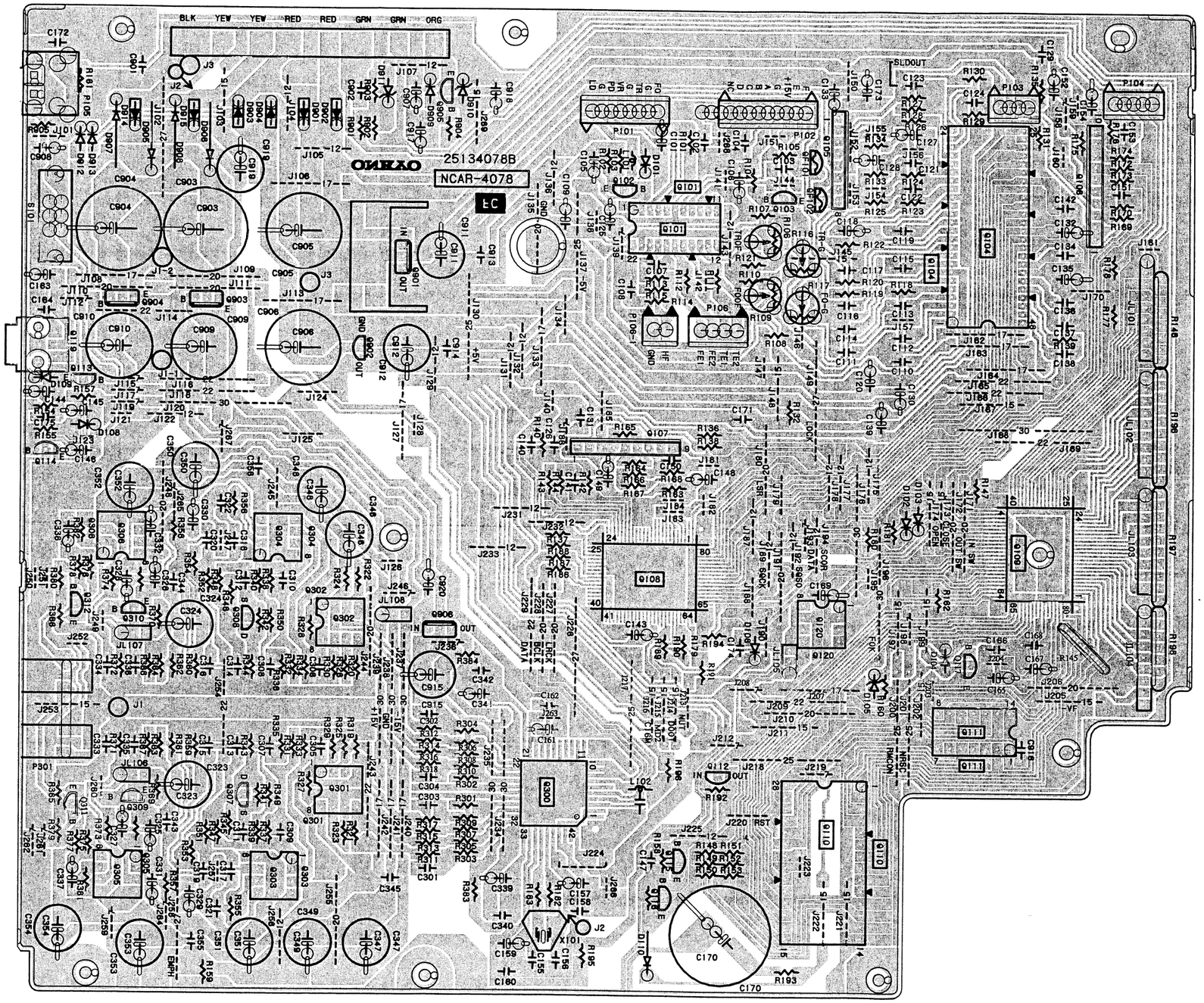
Vertical : 0.2V/div.
Holizontal: 0.5 ms/div.

Adjust R116 until 1.2kHz components of channels 1 and 2 on oscilloscope become same level.
After adjustment, disconnect the AF oscillator and the oscilloscope.

After adjustment, confirm that the center of tracking error signal becomes GND level.



PRINTED CIRCUIT BOARD VIEW FROM BOTTOM SIDE



MAIN CIRCUIT PC BOARD

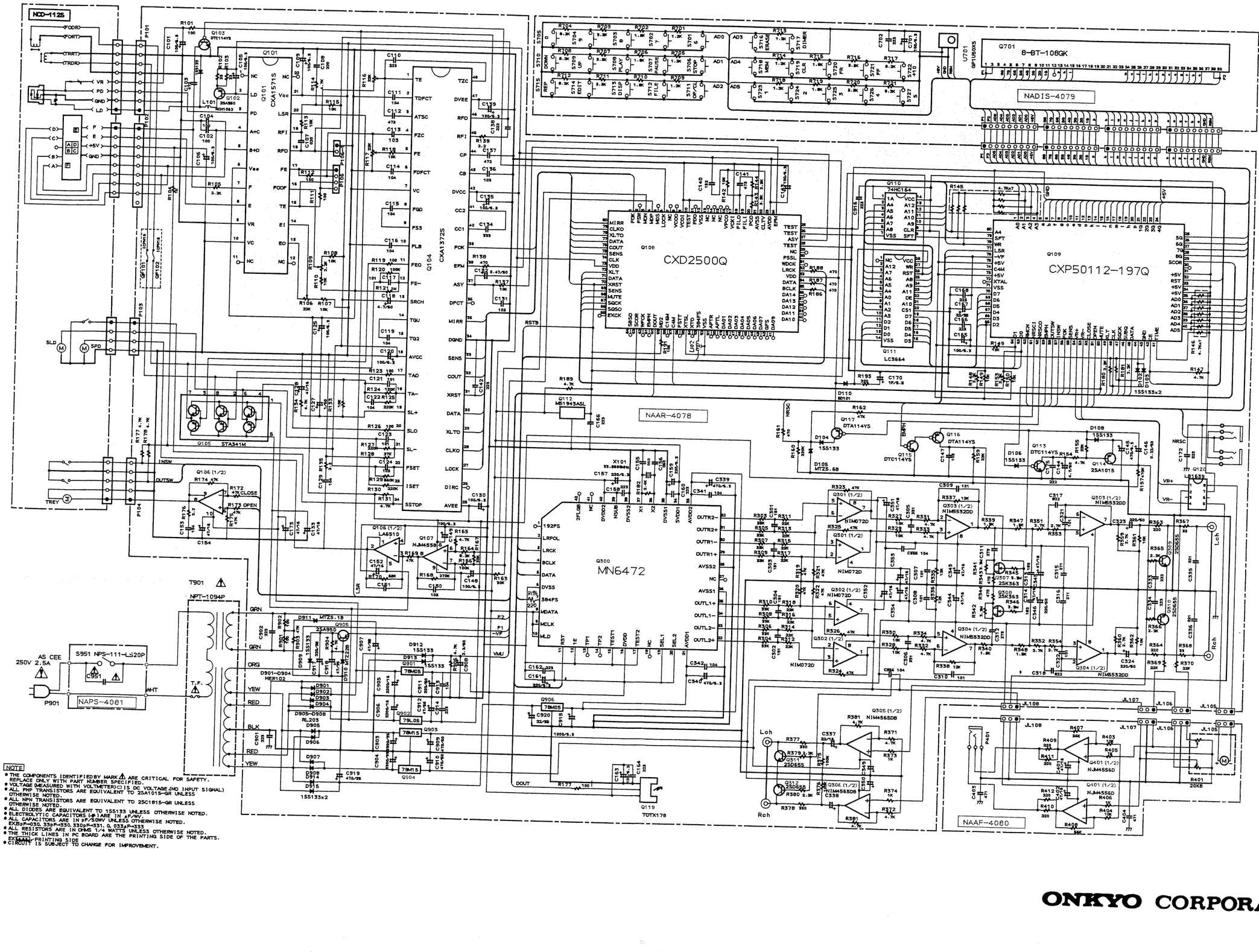
PARTS LIST

MAIN CIRCUIT PC BOARD (NAAR-4078-3A)

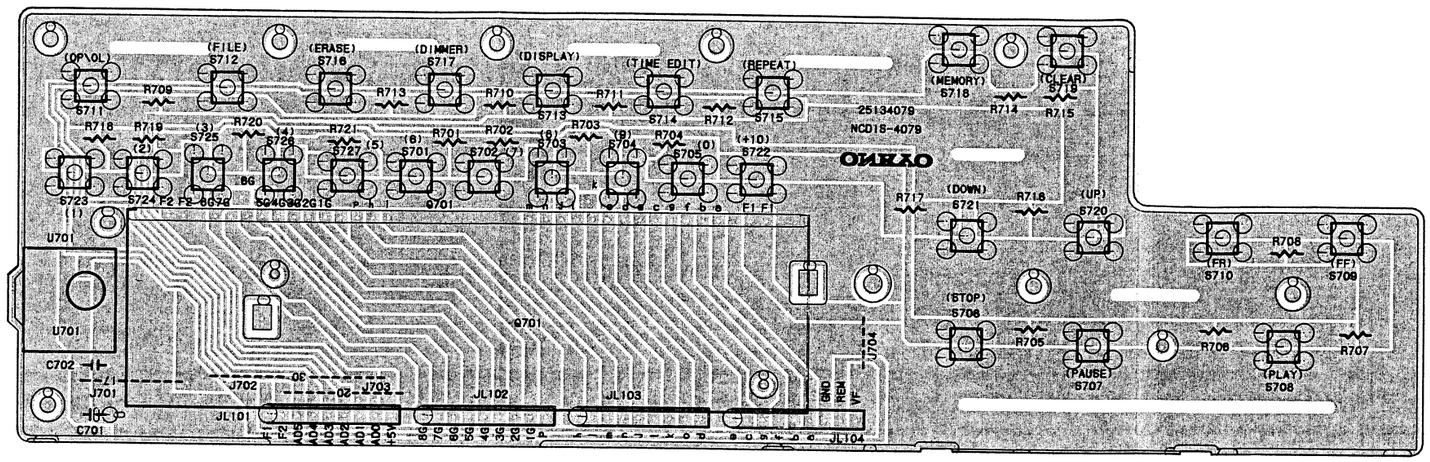
CIRCUIT NO.	PART NO.	DESCRIPTION
	ICs	
Q101	22240404Y	CXA1571S
Q104	22240366	CXA1372S
Q105	22240168	STA341M-L
Q106	22240034	LA6510
Q107	222736	NJM4558S
Q108	22240365	CXD2500Q
Q109	22240405	CXP50112
Q110	22240198	LC3664NL-12
Q111	222741645	74HC164
Q112	22240018	M51943A
Q120	222963 or	LB1630 or
	22240322	LB1639
Q300	22240403	MN6472
Q301,Q302	222735	NJM072D
Q303,Q304	222902	NJM5532D-D
Q305,Q306	22240201	NJM4565D-B
Q901,Q906	222780055MIT	M5F78M05L
Q902	222790053	79L05
Q903	222780155MIT	M5F78M15L
Q904	222790155MIT	M5F79M15L
	Photo coupler	
Q119	24120031	TOTX178
	Transistors	
Q102,Q905	2211503 or	2SA950-O or
	2211504	2SA950-Y
Q103	221281	DTC114YS
Q113,Q115	221281	DTC114YS
Q114	2211455	2SA1015-GR
Q116,Q117	2213090	DTA114YS
Q307,Q308	2212524	2SK363-GR
Q309-Q312	2211705 or	2SD655-E or
	2211706	2SD655-F
	IC protectors	
QF101,QF102	252112	⚠ ICP-N15
	Diodes	
D101-D104	223163	1SS133
D105	224450562	MTZ5.6B
D106-D108	223163	1SS133
D110	223191	SD101
D901-D904	22380029	HER102
D905-D908	22380045	RL203
D909	223163	1SS133
D910	224452202	MTZ22B
D911	224450512	MTZ5.1B
D912-D915	223163	1SS133
	X'tal	
X101	3010173	33.8688MHz
	Coil	
L101	231023	NCH-1062
	Filter	
L102	3030001	DSS306-55B 470M

DX-6830

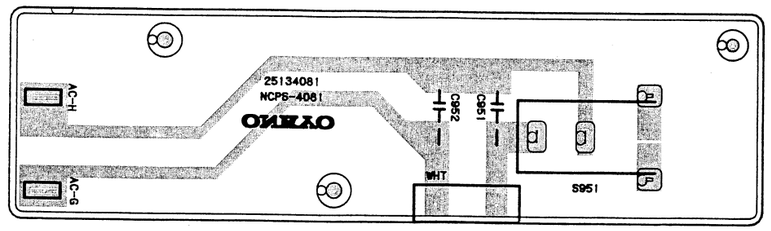
SCHEMATIC DIAGRAM



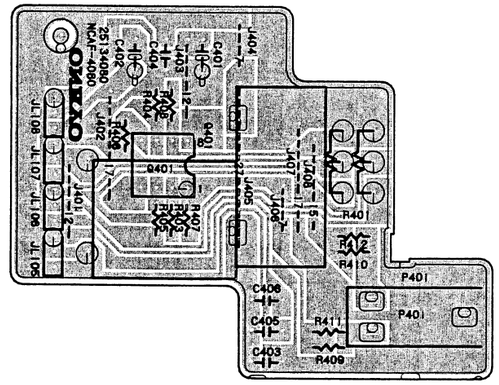
PRINTED CIRCUIT BOARD VIEW FROM BOTTOM SIDE



DISPLAY CIRCUIT PC BOARD



POWER SUPPLY PC BOARD



HEADPHONE AMPLIFIER PC BOARD

CIRCUIT NO.	PART NO.	DESCRIPTION
	Capacitors	
C101,C105	354721019	100 μ F,6.3V,Elect.
C103,C137	374724724	4700pF±5%,50V,TF
C106,C109	354721019	100 μ F,6.3V,Elect.
C110	374722234	0.022 μ F±5%,50V,TF
C111	374721044	0.1 μ F±5%,50V,TF
C112,C141	374724734	0.047 μ F±5%,50V,TF
C113,C124	374721034	0.01 μ F±5%,50V,TF
C114-C116	374721044	0.1 μ F±5%,50V,TF
C118,C144	354780479	4.7 μ F,50V,Elect.
C119,C122	374721044	0.1 μ F±5%,50V,TF
C120,C125	354721019	100 μ F,6.3V,Elect.
C127	354780109	1 μ F,50V,Elect.
C128,C133	354744709	47 μ F,16V,Elect.
C129,C153	374721044	0.1 μ F±5%,50V,TF
C130,C135	354721019	100 μ F,6.3V,Elect.
C131,C136	374721034	0.01 μ F±5%,50V,TF
C132	354784799	0.47 μ F,50V,Elect.
C134	374723334	0.033 μ F±5%,50V,TF
C138,C175	374722224	2200pF±5%,50V,TF
C139,C143	354721019	100 μ F,6.3V,Elect.
C140	374721524	1500pF±5%,50V,TF
C145	354724719	470 μ F,6.3V,Elect.
C146	354782299	0.22 μ F,50V,Elect.
C147,C150	374721034	0.01 μ F±5%,50V,TF
C148,C149	354721019	100 μ F,6.3V,Elect.
C152,C154	354744709	47 μ F,16V,Elect.
C157,C159	354722219	220 μ F,6.3V,Elect.
C161	354722219	220 μ F,6.3V,Elect.
C163,C165	354721019	100 μ F,6.3V,Elect.
C167	354762209	22 μ F,35V,Elect.
C169	354721019	100 μ F,6.3V,Elect.
C173	354744709	47 μ F,16V,Elect.
C301-C304	373301514	150pF±5%,125V,PP
C305,C306	373303314	330pF±5%,125V,PP
C307-C310	373301014	100pF±5%,125V,PP
C311,C312	374722734	0.027 μ F±5%,50V,TF
C313,C314	374728214	820pF±5%,50V,TF
C315,C316	373301814	180pF±5%,125V,PP
C317,C318	374723924	3900pF±5%,50V,TF
C321,C322	373301014	100pF±5%,125V,PP
C323,C324	354782219	220 μ F,50V,Elect.
C333,C334	374722224	2200pF±5%,50V,TF
C335,C336	372122214	220pF±5%,50V,Styrene
C337,C338	354742209	22 μ F,16V,Elect.
C339,C341	354724719	470 μ F,6.3V,Elect.
C346	354782219	220 μ F,50V,Elect.
C348,C349	354782219	220 μ F,50V,Elect.
C350	354742219	220 μ F,16V,Elect.
C351	354782219	220 μ F,50V,Elect.
C352-C354	354742219	220 μ F,16V,Elect.
C355,C356	374721044	0.1 μ F±5%,50V,TF
C903,C904	393163327	3300 μ F,35V,Elect.
C905,C906	354742229	2200 μ F,16V,Elect.
C907,C918	354764709	47 μ F,35V,Elect.
C908	354780229	2.2 μ F,50V,Elect.
C909,C910	354784719	470 μ F,50V,Elect.
C911	354782219	220 μ F,50V,Elect.
C912	354784709	47 μ F,50V,Elect.
C915	354721029	1000 μ F,6.3V,Elect.
C917	354762219	220 μ F,35V,Elect.
C919	354764719	470 μ F,35V,Elect.
C920	354762209	22 μ F,35V,Elect.
	Resistors	
R106	5210066	N06HR22KBD,Semi-fixed
R109	5210060	N06HR2.2KBD,Semi-fixed
R116,R117	5210066	N06HR22KBD,Semi-fixed
R145	49163472407	RM1/101J 4.7K×7,Network
R146	49121472407	RM1/8GJ 4.7K×7,Network
	Plugs	
P101	25055152	NPLG-8P136
P102	25055153	NPLG-9P137
P103	25055148	NPLG-4P132
P104	25055149	NPLG-5P133
P106	25055045	NPLG-4P33
P106-1	25055038	NPLG-2P29
	Jack	
P105	25045172	HSJ1003-01-020
	Terminal	
P301	25045267	NPJ-4PDBL134,Output
	Socket	
SC101	2009990067	NSAS-2P0103
	Holder	
	27190751	

NOTE: THE COMPONENTS IDENTIFIED BY MARK ⚠ ARE CRITICAL FOR RISK OF FIRE AND ELECTRIC SHOCK. REPLACE ONLY WITH PART NUMBER SPECIFIED.

DISPLAY CIRCUIT PC BOARD(NADIS-4079-3)

CIRCUIT NO.	PART NO.	DESCRIPTION
	Remote control sensor	
U701	24130003	GP1U50XS
	Capacitor	
C701	353721019	100MF,6.3V,Elect.
	Push switches	
S701-S727	25035548	NPS-111-S510
	FL tube	
Q701	212092	8-BT-108GK
	Holder	
	27190754Y	FL

HEADPHONE AMPLIFIER PC BORAD (NAAF-4080-3)

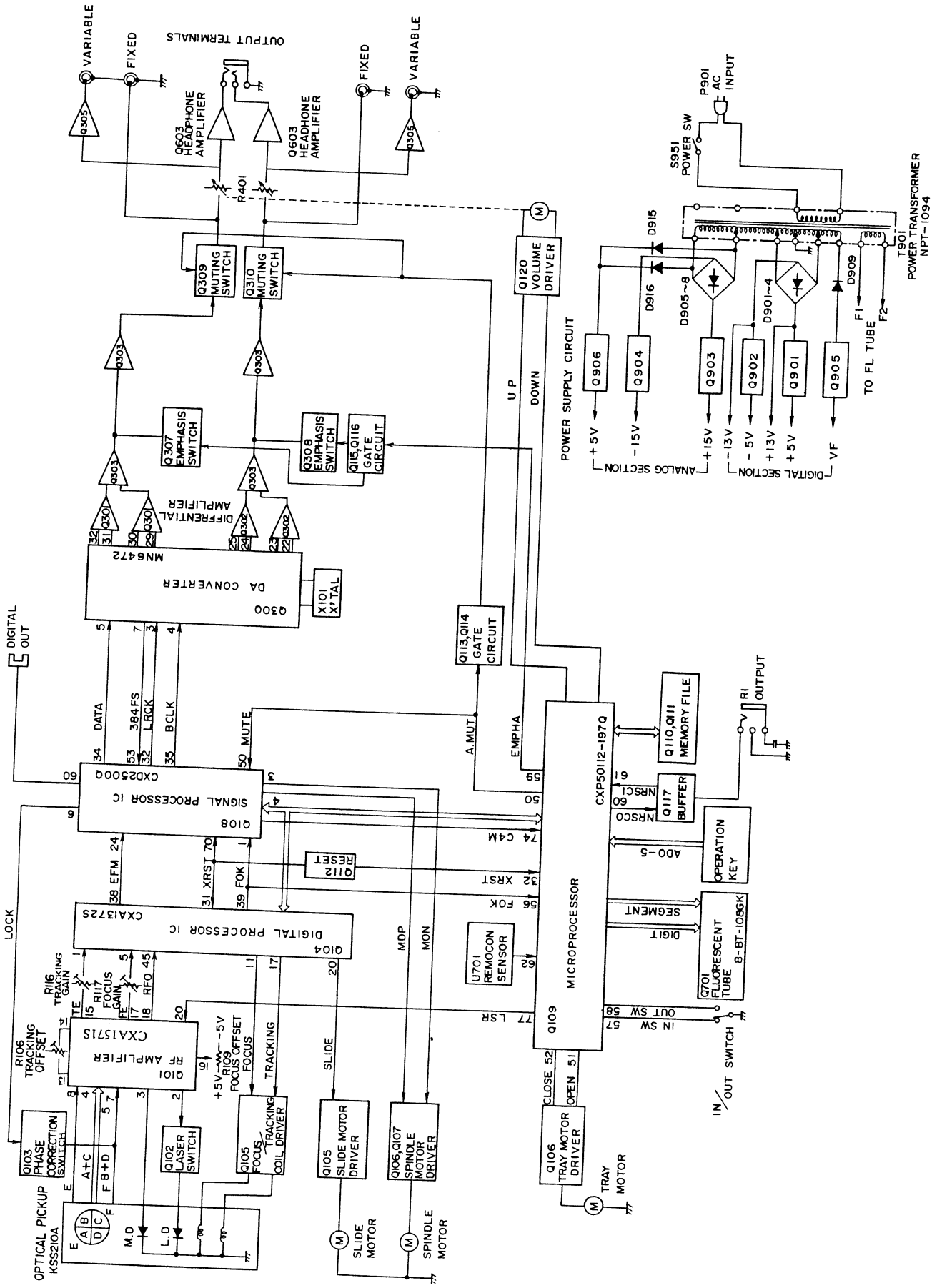
CIRCUIT NO.	PART NO.	DESCRIPTION
Q401	222654	NJM4556D,IC
C401,C402	354744709	47MF,16V,Elect. capacitors
R401	5104242Y	N16RGM20KB30F, Variable resistor
P401	25045164	HLJ4317-01-3020, Headphone jack

POWER SUPPLY PC BOARD(NAPS-4081-3)

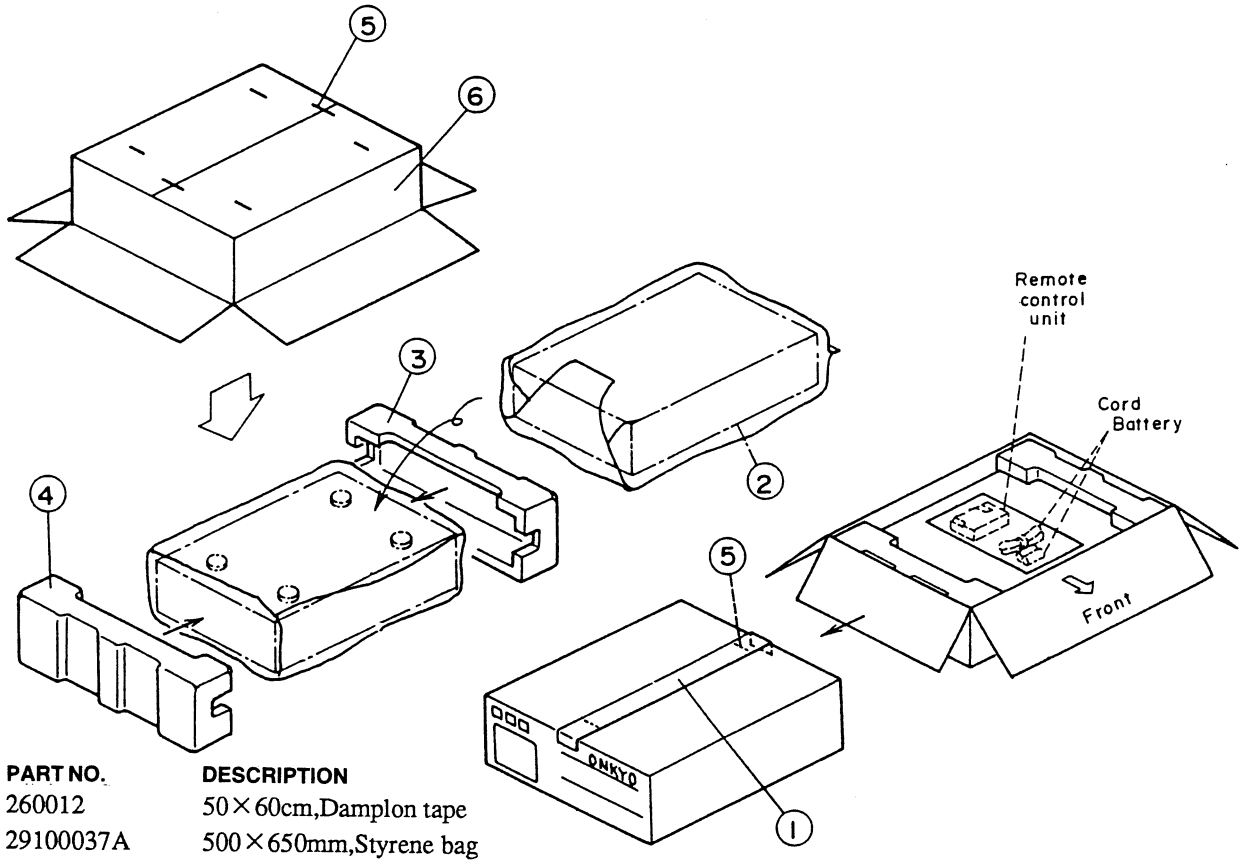
CIRCUIT NO.	PART NO.	DESCRIPTION
C951	3500065A	⚠ DE7150FZ103PAC400V/ 125V,IS capacitor
S951	25035558	⚠ NPS-111-S520P, Power switch

DX-6830

BLOCK DIAGRAM



PACKING VIEW



REF NO.	PART NO.	DESCRIPTION
1	260012	50×60cm,Damplon tape
2	29100037A	500×650mm,Styrene bag
3	29091434Y	Pad R
4	29091433Y	Pad L
5	282301	Sealing hook
6	29052131Y	Master carton box <Black model>
	29052132Y	Master carton box <Silver model>
	Accessary bag ass'y	
	2010098A	Connection cable
	2010200	Connection cable for remote control
	24140193Y	RC-193C,Remote control transmitter
	3010054	UM-3,Two batteries
	29341579Y	Instruction manual
	29100097Y	350×250mm,Styrene bag
	29365020B	Warranty card
	29100094A	Styrene bag for warranty card

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